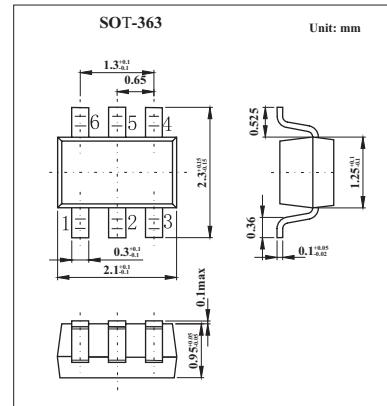


High Voltage Double Diode

BAW101S

■ Features

- Small plastic SMD package
- High switching speed: max. 50 ns
- High continuous reverse voltage: 300 V
- Electrically insulated diodes.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Conditions	Min	Max	Unit
Per diode					
continuous reverse voltage	VR		300		V
		series connection	600		
repetitive peak forward current	VRMM		300		V
		series connection	600		
continuous forward current	IF	single diode loaded;	250		mA
		double diode loaded;	140		
repetitive peak forward current	IFRM		625		mA
non-repetitive peak forward current	IFSM	square wave; T _j = 25°C prior to surge; t = 1 μ s	4.5		A
total power dissipation	P _{tot}	T _s = 25°C	350		mW
storage temperature	T _{stg}		-65	+150	°C
junction temperature	T _j			150	°C
operating ambient temperature	T _{amb}		-65	+150	°C
thermal resistance from junction to soldering point	R _{thj-s}			255	K/W
thermal resistance from junction to ambient	R _{thj-a}			357	K/W

BAW101S■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Max	Unit
reverse breakdown voltage	$V_{BR(R)}$	$I_R = 100 \mu\text{A}$	300		
forward voltage	V_F	$I_F = 100 \text{ mA}$; note 1		1.1	mV
reverse current	I_R	$V_R = 25 \text{ V}$		150	nA
		$V_R = 250 \text{ V}; T_{amb} = 150^\circ\text{C}$		50	μA
reverse recovery time	t_{rr}	when switched from $I_F = 30 \text{ mA}$ to $I_R = 30 \text{ mA}$; $R_L = 100 \Omega$; measured at $I_R = 3 \text{ mA}$;		50	ns
diode capacitance	C_d	$V_R = 0$; $f = 1 \text{ MHz}$;		2	pF

Note

1. Pulse test: pulse width = 300 μs ; $\delta = 0.02$.

■ Marking

Marking	K2
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